

MOSFET

600V CoolMOS™ C7 Power Transistor

CoolMOS™ C7 is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

600V CoolMOS™ C7 series combines the experience of the leading SJ MOSFET supplier with high class innovation.

The 600V C7 is the first technology ever with R_{DS(on)}*A below 10hm*mm².

Features

- Suitable for hard and soft switching (PFC and high performance LLC)
- Increased MOSFET dv/dt ruggedness to 120V/ns
- Increased efficiency due to best in class FOM R_{DS(on)}*E_{oss} and R_{DS(on)}*Q_g
- Best in class R_{DS(on)} /package
- · Easy to use/drive
- Pb-free plating, halogen free mold compound
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)
- 4pin kelvin source concept

Benefits

- Increased economies of scale by use in PFC and PWM topologies in the application
- Higher dv/dt limit enables faster switching leading to higher efficiency
- Enabling higher system efficiency by lower switching losses
- Increased power density solutions due to smaller packages
- Suitable for applications such as server, telecom and solar
- Up to 0.5% better full load efficiency @100kHz compared to conventional 3pin package

Applications

PFC stages and PWM stages (TTF, LLC) for high power/performance SMPS e.g. Computing, Server, Telecom, UPS and Solar.

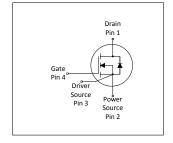
Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Value	Unit
650	V
17	m $Ω$
240	nC
495	A
129	A
30	μJ
200	A/µs
	650 17 240 495 129

Type / Ordering Code	Package	Marking	Related Links
IPZ60R017C7	PG-TO 247-4	60C7017	see Appendix A











600V CoolMOS™ C7 Power Transistor IPZ60R017C7



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600V CoolMOS™ C7 Power Transistor IPZ60R017C7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Values			s		Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	109 69	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	495	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	582	mJ	I _D =12.6A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	2.91	mJ	I _D =12.6A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	12.6	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	446	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	109	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	495	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	20	V/ns	V_{DS} =0400V, I_{SD} <=12.6A, T_j =25°C see table 8	
		V_{DS} =0400V, I_{SD} <=12.6A, T_{j} =25°C see table 8					
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch

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2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Cumbal	Values			11:4	Nata / Tast Candition	
Parameter	ameter Symbol Min.		Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.28	°C/W	-	
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded	
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.	
Soldering temperature, wavesoldering only allowed at leads	T_{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

600V CoolMOS™ C7 Power Transistor IPZ60R017C7



3 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 **Static characteristics**

Danier de la constante de la c	Ol		Values			
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	V _{(GS)th}	3	3.5	4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=2.91{\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 50	2	μА	V _{DS} =600, V _{GS} =0V, T _j =25°C V _{DS} =600, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.015 0.033	0.017	Ω	V _{GS} =10V, I _D =58.2A, T _j =25°C V _{GS} =10V, I _D =58.2A, T _j =150°C
Gate resistance	R _G	-	0.45	-	Ω	f=1MHz, open drain

Dynamic characteristics Table 5

Parameter	Ols all	Values			11	N 4 4 7 4 9 199	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	9890	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	200	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	375	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	3840	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	t _{d(on)}	-	30	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Rise time	t _r	-	13	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Turn-off delay time	$t_{\sf d(off)}$	-	106	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Parameter	Combal		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	50	-	nC	V_{DD} =400V, I_{D} =58.2A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	85	-	nC	V_{DD} =400V, I_{D} =58.2A, V_{GS} =0 to 10V
Gate charge total	Q_{g}	-	240	-	nC	V_{DD} =400V, I_{D} =58.2A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.0	-	V	V_{DD} =400V, I_{D} =58.2A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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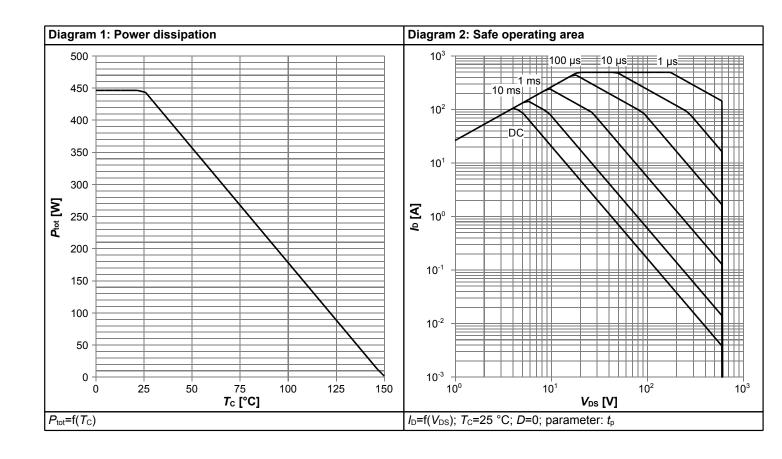


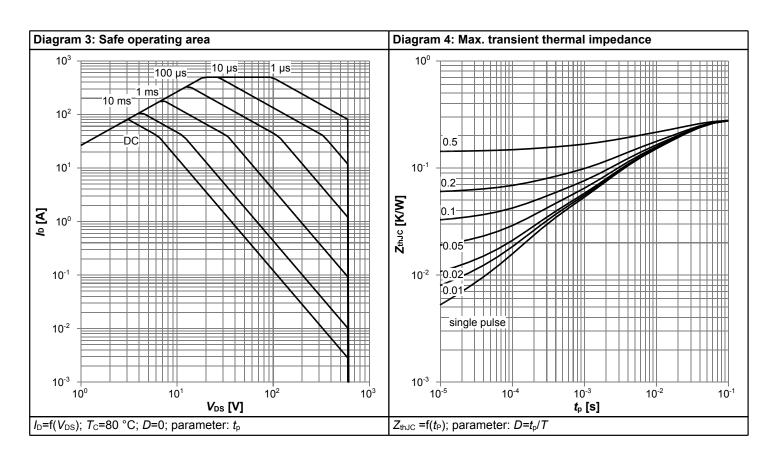
Table 7 Reverse diode characteristics

Davamatav	Cumbal	Values			11	Nata / Tant Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =58.2A, T _j =25°C	
Reverse recovery time	t _{rr}	-	630	-	ns	V_R =400V, I_F =58.2A, di_F/dt =100A/ μ s; see table 8	
Reverse recovery charge	Q _{rr}	-	18	-	μC	V_R =400V, I_F =58.2A, di_F/dt =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	_	55	-	А	V_R =400V, I_F =58.2A, di_F/dt =100A/ μ s; see table 8	

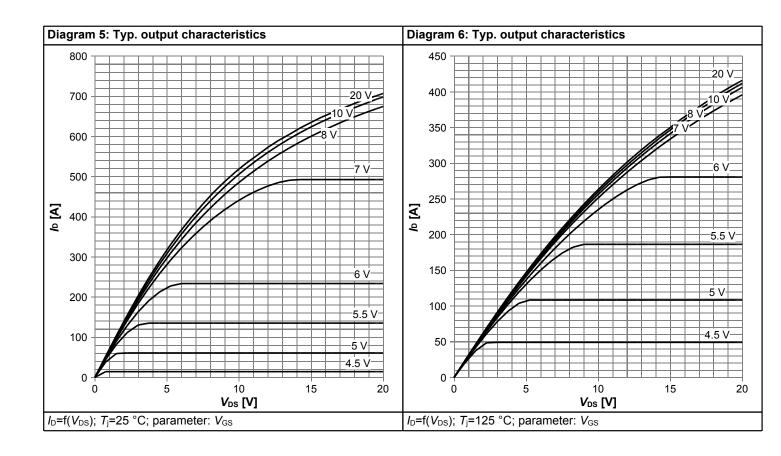


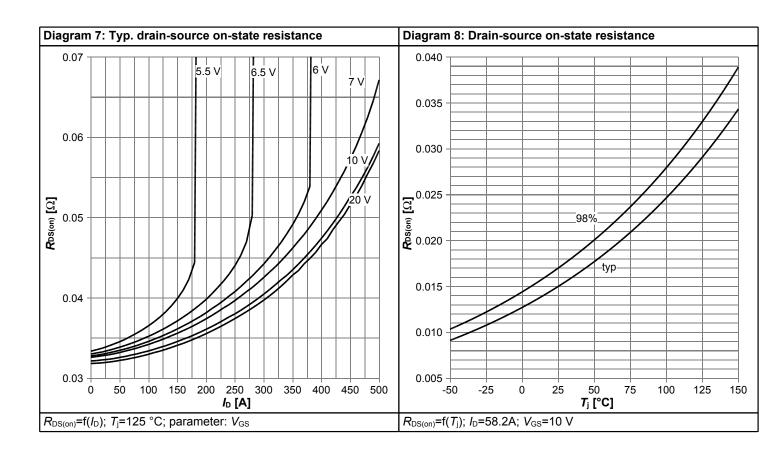
4 Electrical characteristics diagrams



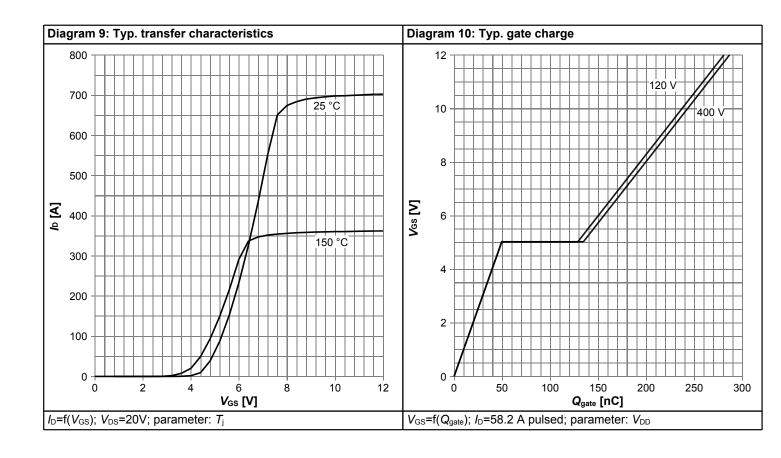


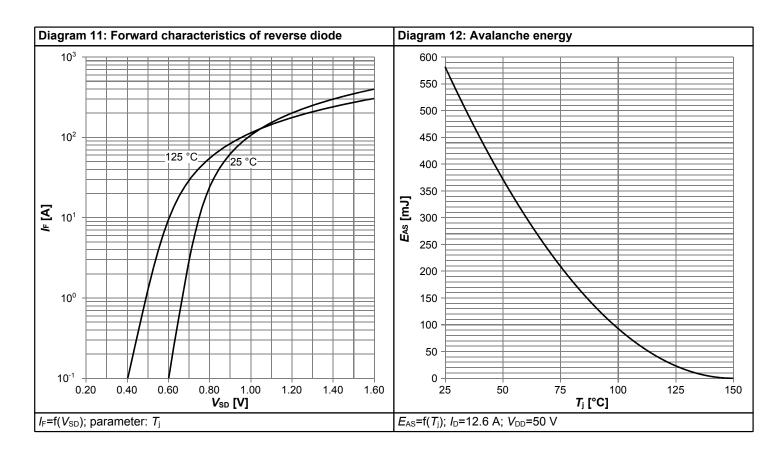




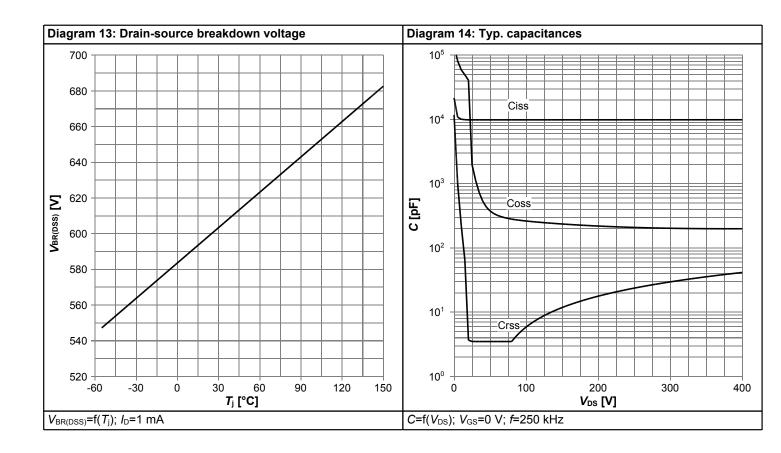


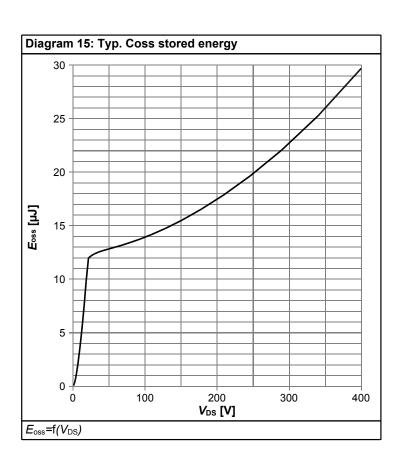














5 Test Circuits

Table 8 Diode characteristics

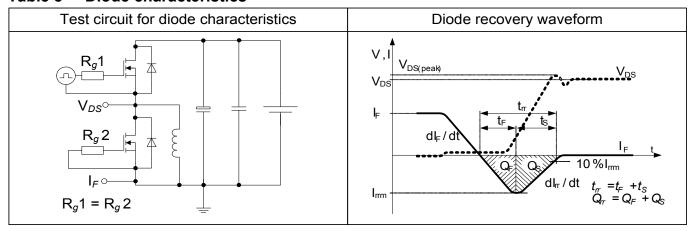


Table 9 switching times (ss)

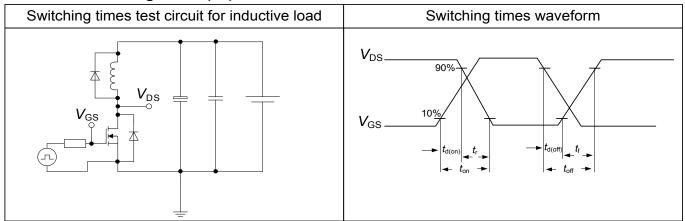
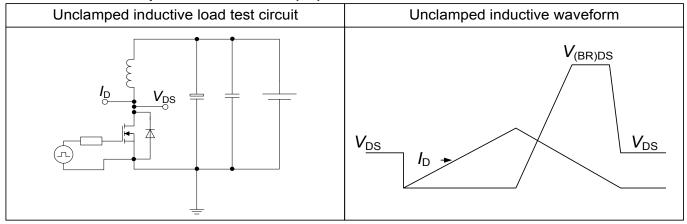
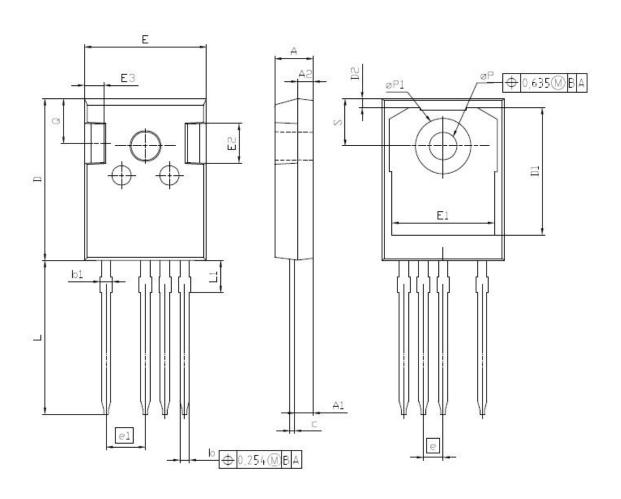


Table 10 Unclamped inductive load (ss)





6 Package Outlines



DIM	MILLIM	INCHES			
DIM	MIN	MAX	MIN	MAX	
Α	4.83	5.21	0.190	0.205	
A1	2.29	2.54	0.090	0.100	
A2	1.90	2.16	0.075	0.085	
b	1.07	1.33	0.042	0.052	
b1	1.10	1.70	0.043	0.067	
С	0.50	0.70	0.020	0.028	
D	20.80	21.10	0.819	0.831	
D1	16.25	17.65	0.640	0.695	
D2	0.95	1.35	0.037	0.053	
E	15.70	16.13	0.618	0.635	
E1	13.10	14.15	0.516	0.557	
E2	3.68	5.10	0.145	0.201	
E3	1.00	2.60	0.039	0.102	
е	2.54	(BSC)	0.100	(BSC)	
e1	5.	08	0.200		
N		4		4	
L	19.72	20.32	0.776	0.800	
L1	4.02	4.40	0.158	0.173	
øР	3.50	3.70	0.138	0.146	
øP1	7.00	7.40	0.276	0.291	
Q	5.49	6.00	0.216	0.236	
S	6.04	6.30	0.238	0.248	

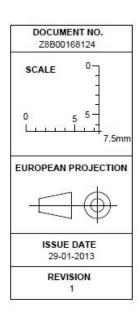


Figure 1 Outline PG-TO 247-4

600V CoolMOS[™] C7 Power Transistor IPZ60R017C7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS™ C7 Webpage: www.infineon.com

• IFX CoolMOS[™] C7 application note: <u>www.infineon.com</u>

• IFX CoolMOS™ C7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

600V CoolMOS™ C7 Power Transistor





Revision History

IPZ60R017C7

Revision: 2016-03-01, Rev. 2.0

Previous	Revision
FIEVIOUS	LENSION

Revision	Date	Subjects (major changes since last revision)
2.0	2016-03-01	Release of final version

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Trademarks updated August 2015

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Final Data Sheet 14 Rev. 2.0, 2016-03-01